
JL6973D Datasheet

Zhuhai Jieli Technology Co.,LTD

Version: 1.3

Date: 2025.01.15

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JL6973D Features

CPU

- 32-bit DSP supports hardware Float Point Unit(FPU)
- Up to 160MHz programmable processor
- 64Vectored interrupts
- 8 Levels interrupt priority

DSP Audio Processing

- SBC, AAC Audio decodes supported for BT audio
- mSBC voice codec supported for BT phone
- Supports MP2, MP3, WMA, APE, FLAC, AAC, MP4, M4A, WAV, AIF, AIFC audio decoding
- Packet Loss Concealment (PLC) for voice processing
- Acoustic echo cancellation/suppression (AEC,AES)
- Single/Dual analog/digital MIC Environmental Noise Cancellation (ENC)
- Multi-band DRC limiter
- 20-band EQ configuration for voice Effects

Audio Codec

- Two channels 24-bit DAC, SNR >= 101dB
- Two channels 24-bit ADC , SNR >= 85dB
- Sampling rates of 8KHz/11.025KHz/16KHz/22.05KHz/24KHz/32KHz/44.1KHz/48KHz are supported
- One analog MIC amplifier, build-in MIC bias generator
- Supports two PDM digital MIC inputs
- One channel Stereo analog MUX
- Supports cap-less, single-ended, and differential mode at the DAC path
- Supports 16ohm and 32ohm Speaker loading

Bluetooth

- Compliant with Bluetooth V6.0+BR+EDR+BLE specification

(DN Q334307)

- Meet class2 and class3 transmitting power requirement
- Support GFSK and $\pi/4$ DQPSK all packet types
- Provides maximum +8dbm transmitting power
- receiver with minimum -94dBm sensitivity
- Fast AGC for enhanced dynamic range
- Support a2dp\avctp\avdtp\avrcp\hfp\spp\smpl\att\gap\gatt\rfcomm\sdp\l2cap profile
- a2dp 1.4\avctp 1.4\avdtp 1.3\ avrcp 1.6.3\hfp 1.9\spp 1.2\rfcomm 1.2\pnp 1.3\hid 1.1.1\sdp core 6.0\l2cap core 6.0

Peripherals

- One full speed USB 2.0 OTG controller
- Six multi-function 32-bit timers, support capture and PWM mode
- Three full-duplex basic UART, support DMA mode
- One hardware IIC interface supports host and device mode
- Two Built-in low power Cap Sense Keys
- Built-in Cap Sense Key controller
- 10-bit ADC for analog sampling
- External wake up/interrupt on all GPIOs

PMU

- Low voltage LDO and DC-DC for internal digital and analog circuit supply
- 2uA current consumption in the soft-off mode
- Built-in LDO and DC-DC for the core, I/O, Bluetooth and flash
- VBAT is 2.2V to 4.5V
- VDDIO is 2.2V to 3.4V

Packages

- QFN20(3mm*3mm)

Temperature

- Operating temperature: -40°C to +85°C
- Storage temperature: -65°C to +150°C

Applications

- Bluetooth TWS headsets



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1、 Pin Definition

1.1 Pin Assignment

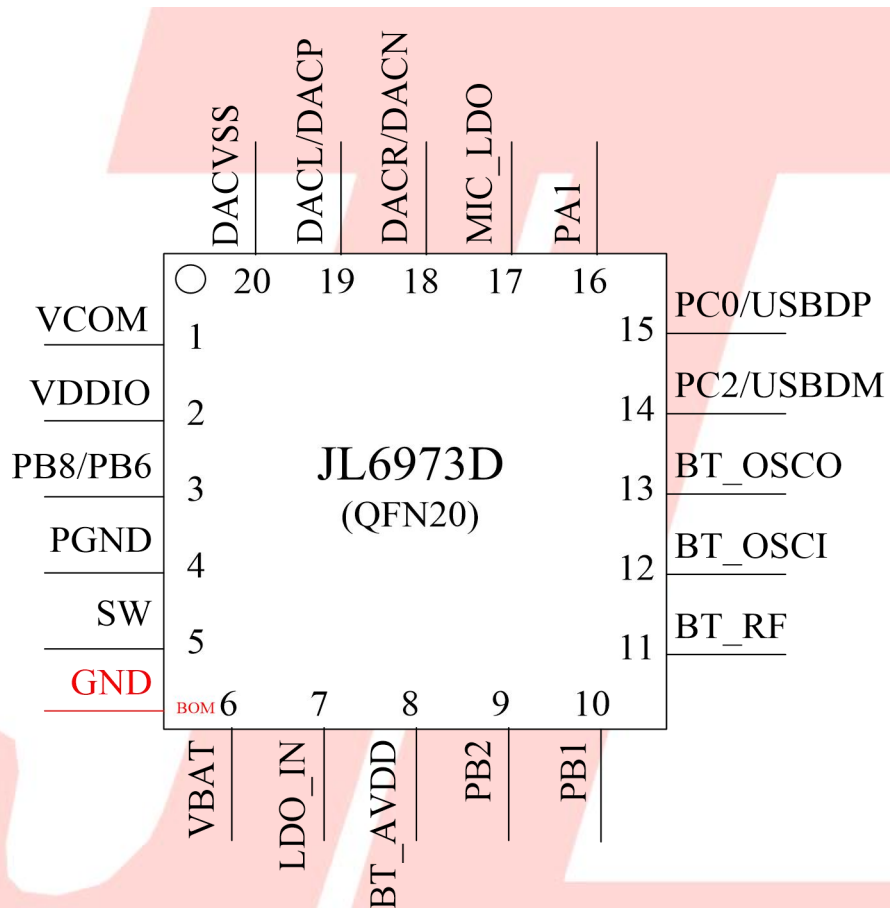


Figure 1-1 JL6973D Package Diagram

1.2 Pin Description

Table 1-1 JL6973D Pin Description

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
1	VCOM	P	/		DAC reference voltage
2	VDDIO	P	/		IO Power 3.3v
3	PB8	I/O	8/24	GPIO	MIC1: MIC1 Input Channel; UART0RXB: Uart0 Data Input(B); CAP4: Timer4 Capture;
	PB6	I/O	8/24	GPIO	UART1RXA: Uart1 Data Input(A); PWM2: Timer2 PWM Output; ADC9: ADC Input Channel 9; Touch7: Touch Input Channel 7;
4	PGND	P	/		DCDC Ground
5	SW	P	/	DCDC output	DCDC switch output, connected to inductor
6	VBAT	P	/		connect to battery
7	LDO_IN	P	/		Charge Power Input; UART0TXC: Uart0 Data Output(C); UART0RXC: Uart0 Data Input(C); PWM3: Timer3 PWM Output; CAP1: Timer1 Capture;
8	BT_AVDD	P	/		BT Power
9	PB2	I/O	8/24	GPIO	UART2RXC: Uart2 Data Input(C); SPI2DOC: SPI2 Data Out(C); CAP5: Timer5 Capture; ADC7: ADC Input Channel 7; LP_TH1: Low Power Touch Channel 1
10	PB1	I/O	8/24	GPIO (pull up)	Long Press Reset; SPI2CLKC: SPI2 Clk(C); UART2TXC: Uart2 Data Output(C) ADC6: ADC Input Channel 6; LP_TH0: Low Power Touch Channel 0
11	BT_RF	/	/		BT Antenna
12	BT_OSCI	I	/		BTOSC In
13	BT_OSCO	O	/		BTOSC Out
14	PC2	I/O	8/24		IIC_SCL_C: IIC SCL(C); UART0TXD: Uart0 Data Output(D); TMR1: Timer1 Clock Input;

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	USBDM	I/O	4	USB Negative Data	UART1RXD: Uart1 Data Input(D); IIC_SDA_A: IIC SDA(A); ADC11: ADC Input Channel 11;
15	USBDP	I/O	4	USB Positive Data	UART1TXD: Uart1 Data Output(D); IIC_SCL_A: IIC SCL(A); ADC10: ADC Input Channel 10;
	PC0	I/O	8	GPIO	UART1TXB: Uart1 Data Output(B);
16	PA1	I/O	8/24	GPIO	MIC0: MIC0 Input Channel ; PWM0: Timer0 PWM Output; UART1TXC: Uart1 Data Output(C);
17	MIC_LDO	P	/		MIC Power
18	DACR/DACN	O	/		DAC Right Channel Different DAC Negative Channel
19	DACL/DACP	O	/		DAC Left Channel Different DAC Positive Channel
20	DACVSS	P	/		Analog Ground

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2、Electrical Characteristics

2.1 Absolute Maximum Ratings

Table 2-1

Symbol	Parameter	Min	Max	Unit
Tamb	Ambient Temperature	-40	+85	°C
Tstg	Storage temperature	-65	+150	°C
VBAT	Supply Voltage	-0.3	4.5	V
LDO_IN	Charger Voltage	-0.3	6	V
V _{3.3IO}	3.3V IO Input Voltage	-0.3	3.6	V

Note : The chip can be damaged by any stress in excess of the absolute maximum ratings listed below

2.2 PMU Characteristics

Table 2-2

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
VBAT	Voltage Input	2.2	3.7	4.2	V	
LDO_IN	Charger supply Voltage	4.5	5.0	5.5	V	
Normal mode						
VDDIO	Voltage output	—	3.0	—	V	VBAT = 4.2V, 10mA loading
	Loading current	—	—	100	mA	VDDIO=3V@VBAT = 4.2V
BT_AVDD	Voltage output	—	1.3	—	V	VDDIO=3.0V, 10mA loading
	Loading current	—	—	60	mA	BT_AVDD=1.25V@VDDIO=3.0v
LP mode						
VDDIO	Loading current			5	mA	VDDIO=3V@VBAT = 4.2V

2.3 Battery Charge

Table 2-3

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
LDO_IN	Charge Input Voltage	4.5	5	5.5	V	—
V _{Charge}	Charge Voltage	4.15	4.2	4.25	V	LDO_IN>4.5V
		4.30	4.35	4.40	V	LDO_IN>4.65V

I_{Charge}	Charge Current	20		200	mA	Charge current at fast charge mode
I_{Trikl}	Trickle Charge Current	20	45	70	mA	$V_{\text{BAT}} < V_{\text{Trikl}}$

2.4 IO Input/Output Electrical Logical Characteristics

Table 2-4

IO input characteristics						
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{IL}	Low-Level Input Voltage	-0.3	—	$0.3 * V_{\text{DDIO}}$	V	$V_{\text{DDIO}} = 3.3\text{V}$
V_{IH}	High-Level Input Voltage	$0.7 * V_{\text{DDIO}}$	—	$V_{\text{DDIO}} + 0.3$	V	$V_{\text{DDIO}} = 3.3\text{V}$
IO output characteristics						
V_{OL}	Low-Level Output Voltage	—	—	0.33	V	$V_{\text{DDIO}} = 3.3\text{V}$
V_{OH}	High-Level Output Voltage	2.7	—	—	V	$V_{\text{DDIO}} = 3.3\text{V}$

2.5 Internal Resistor Characteristics

Table 2-5

Port	General Output	High Drive	Internal Pull-Up Resistor	Internal Pull-Down Resistor	Comment
PA1, PB1,PB2, PB6,PB8, PC2	8mA	24mA	10K	10K	1、PB1 default pull up 2、USBDM & USBDP default pull down 3、internal pull-up/pull-down resistance accuracy $\pm 20\%$
PC0	8mA	-	10K	10K	
USBDP	4mA	—	1.5K	15K	
USBDM	4mA	—	180K	15K	

2.6 DAC Characteristics

Table 2-6

Parameter	Min	Typ	Max	Unit	Test Conditions
Frequency Response	20	—	20K	Hz	1KHz/0dB 10Kohm loading With A-Weighted Filter
THD+N	—	-80	—	dB	
S/N	—	101	—	dB	
Crosstalk	—	-80	—	dB	
Output Swing		0.45		Vrms	1KHz/-60dB
Dynamic Range		90		dB	

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					10Kohm loading With A-Weighted Filter
DAC Output Power	—	20	30	mW	16ohm loading

2.7 ADC Characteristics

Table 2-7

Parameter	Min	Typ	Max	Unit	Test Conditions
Dynamic Range		85		dB	Fsample=44.1kHz Fin=1KHz 2mVpp Input
S/N	—	85	—	dB	Fsample=44.1kHz Fin=1KHz 1.2Vpp Input
THD+N	—	-60	—	dB	
Crosstalk	—	-80	—	dB	

2.8 BT Characteristics

2.8.1 Transmitter

Basic Data Rate

Table 2-8

Parameter	Min	Typ	Max	Unit	Test Conditions
RF Transmit Power		6	8	dBm	25°C, Power Supply VBAT=5V 2441MHz
RF Power Control Range		20		dB	
20dB Bandwidth		950		KHz	
Adjacent Channel	+2MHz	-40		dBm	
	-2MHz	-38		dBm	
Transmit Power	+3MHz	-44		dBm	
	-3MHz	-35		dBm	

Enhanced Data Rate

Table 2-9

Parameter	Min	Typ	Max	Unit	Test Conditions
Relative Power		-1		dB	25°C, Power Supply VBAT=5V 2441MHz
$\pi/4$ DQPSK Modulation Accuracy	DEVM RMS	6		%	
	DEVM 99%	10		%	
	DEVM Peak	15		%	
Adjacent Channel Transmit Power	+2MHz	-40		dBm	
	-2MHz	-38		dBm	
	+3MHz	-44		dBm	
	-3MHz	-35		dBm	

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2.8.2 Receiver

Basic Data Rate

Table 2-10

Parameter		Min	Typ	Max	Unit	Test Conditions
Sensitivity			-92		dBm	25°C, Power Supply VBAT=5V 2441MHz
Co-channel Interference Rejection			-13		dB	
Adjacent Channel Interference Rejection	+1MHz		+5		dB	
	-1MHz		+2		dB	
	+2MHz		+37		dB	
	-2MHz		+36		dB	
	+3MHz		+40		dB	
	-3MHz		+35		dB	

Enhanced Data Rate

Table 2-11

Parameter		Min	Typ	Max	Unit	Test Conditions
Sensitivity			-94		dBm	25°C, Power Supply VBAT=5V 2441MHz
Co-channel Interference Rejection			-13		dB	
Adjacent Channel Interference Rejection	+1MHz		+5		dB	
	-1MHz		+2		dB	
	+2MHz		+37		dB	
	-2MHz		+36		dB	
	+3MHz		+40		dB	
	-3MHz		+35		dB	

2.9 ESD Protection

Parameter	Typ.	Test pin	Reference standard
Human Body Mode	± 4KV	All pins	JEDEC EIA/JESD22-A114
Machine Mode	± 200V	All pins	JEDEC EIA/JESD22-A115
Charge Device Model	± 1KV	All pins	JEDEC EIA/JESD22-C101F
Latch up	± 200mA	All GPIO pins	JEDEC STANDARD NO.78E
	1.5xVopmax	All power pins	

Note : 1.5xVopmax = 1.5 times maximum operating voltage

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3、 Package Information

3.1 QFN20_3.0x3.0

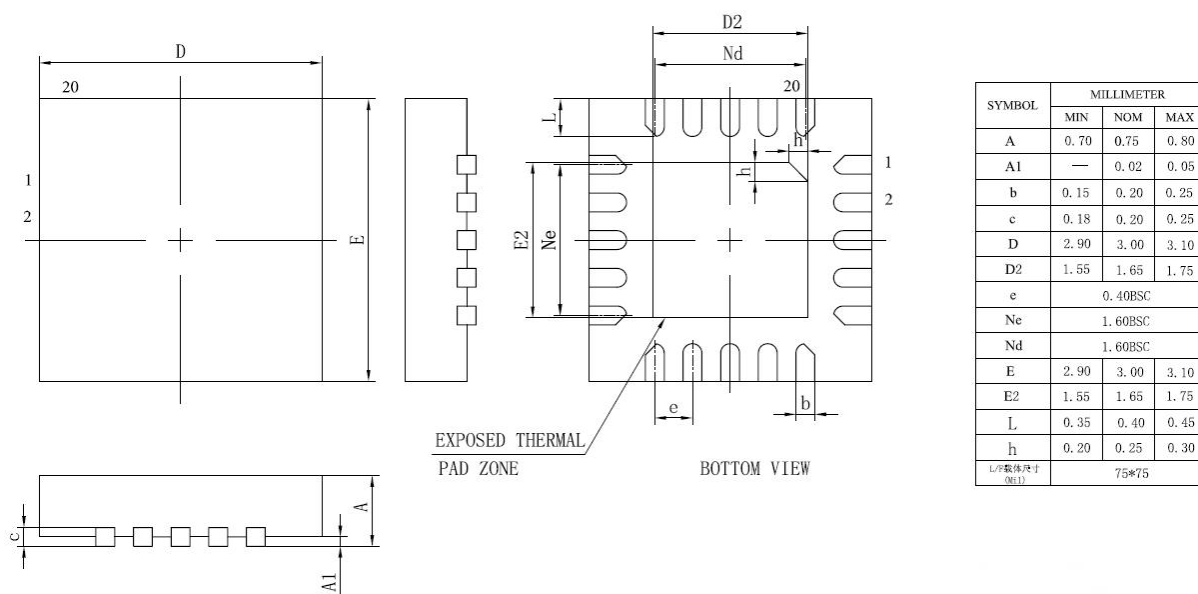
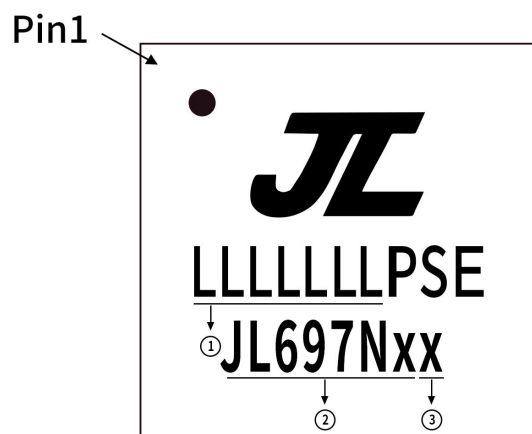


Figure 3-1 JL6973D Package

4、IC Marking information



- ① LLLLLLL: Production Batch
- ② JL697Nx: Chip Model
- ③ x: Built-in Flash Size
 - 0: No Flash
 - 2: 2Mbit
 - 4: 4Mbit
 - 8: 8Mbit
 - 6: 16Mbit
 - 3: 32Mbit

5、Solder-Reflow Condition

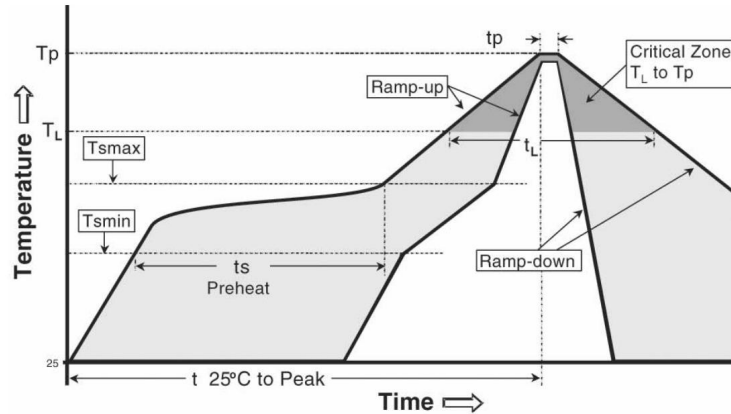


Figure 5-1 Classification Reflow Profile

Classification Profiles

Table 5-1

Profile Feature		Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat /Soak	Temperature Min (T_{smin})	100°C	150°C
	Temperature Max (T_{smax})	150°C	200°C
	Time (ts) from (T_{smin} to T_{smax})	60-120 seconds	60-180 seconds
Average ramp-up rate (T_{smax} to T_p)		3°C/second max	3°C/second max
Liquidous temperature (T_L)		183°C	217°C
Time (t_L) maintained above T_L		60-150 seconds	60-150 seconds
Peak package body temperature (T_p)		See Table 5-2	See Table 5-3
Time within 5°C of actual Peak Temperature (t_p) ²		10-30 seconds	20-40 seconds
Ramp-down rate (T_p to T_L)		6°C/second max	6°C/second max
Time 25°C to peak temperature		6 minutes max	8 minutes max

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Note 2: Time within 5°C of actual peak temperature (t_p) specified for the reflow profiles is a “supplier” minimum and “user” maximum.

SnPb - Classification Temperature

Table 5-2

Package Thickness	Volume mm ³ < 350	Volume mm ³ ≥ 350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

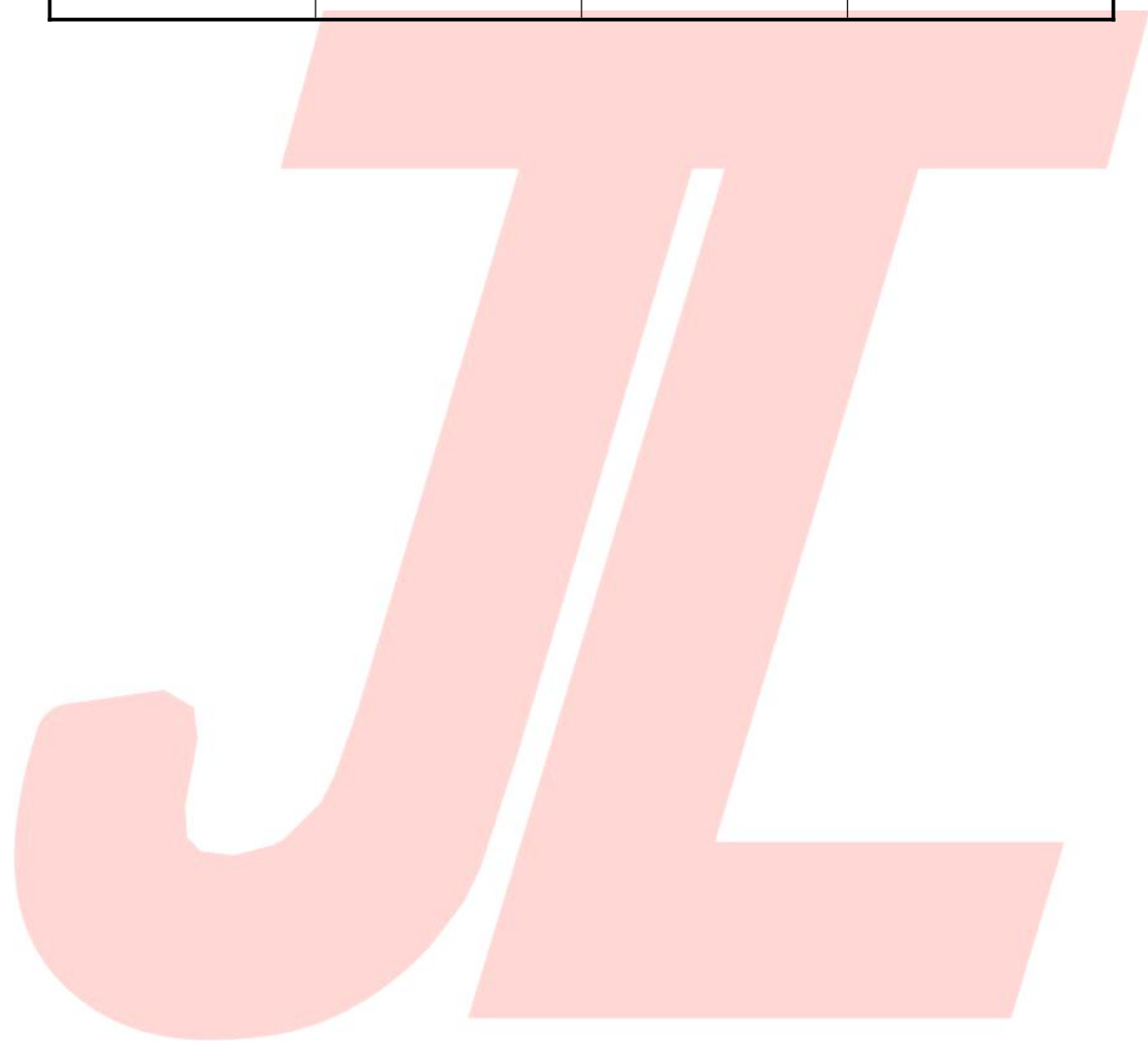
Pb-free - Classification Temperature

Table 5-3

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Package Thickness	Volume mm³ < 350	Volume mm³ 350 - 2000	Volume mm³ > 2000
< 1.6mm	260°C	260°C	260°C
1.6 mm - 2.5mm	260°C	250°C	245°C
> 2.5mm	250°C	245°C	245°C

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6、Revision History

Date	Revision	Description
2022.05.16	V1.0	Initial Release
2023.12.01	V1.1	Update JL6973D BT_Features
2024.08.16	V1.2	Update DAC Characteristics
2025.01.15	V1.3	Update Bluetooth Vision and profiles